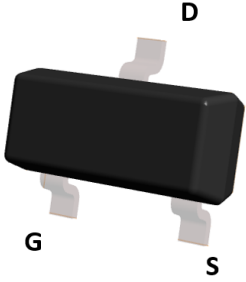
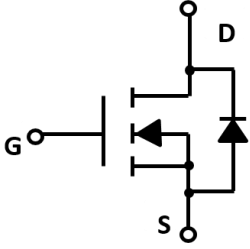
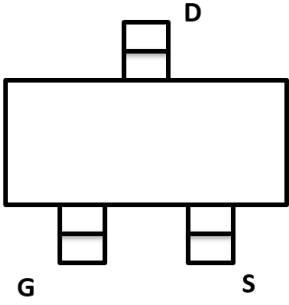


## N-Channel Enhancement Mode Field Effect Transistor



Top View

**SOT-23**



### Product Summary

- $V_{DS}$  50V
- $I_D$  300mA
- $R_{DS(ON)}$  (at  $V_{GS}=10V$ ) <2.5ohm
- $R_{DS(ON)}$  (at  $V_{GS}=4.5V$ ) <3.0ohm

### General Description

- Trench Power MV MOSFET technology
- Voltage controlled small signal switch
- Low input Capacitance
- Fast Switching Speed
- Low Input / Output Leakage

### Applications

- Battery operated systems
- Solid-state relays
- Direct logic-level interface: TTL/CMOS

### ■ Absolute Maximum Ratings ( $T_A=25^\circ C$ unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-source Voltage	$V_{DS}$	50	V
Gate-source Voltage	$V_{GS}$	$\pm 20$	V
Drain Current	$I_D$	300	mA
Pulsed Drain Current <sup>A</sup>	$I_{DM}$	1.5	A
Total Power Dissipation @ $T_A=25^\circ C$	$P_D$	350	mW
Thermal Resistance Junction-to-Ambient @ Steady State <sup>B</sup>	$R_{\theta JA}$	357	$^\circ C / W$
Junction and Storage Temperature Range	$T_J, T_{STG}$	-55~+150	$^\circ C$

## ■ Electrical Characteristics ( $T_J=25^\circ\text{C}$ unless otherwise noted)

Parameter	Symbol	Conditions	Min	Typ	Max	Units
<b>Static Parameter</b>						
Drain-Source Breakdown Voltage	$BV_{DSS}$	$V_{GS}=0V, I_D=250\mu A$	50			V
Zero Gate Voltage Drain Current	$I_{DSS}$	$V_{DS}=50V, V_{GS}=0V$			1	$\mu A$
Gate-Body Leakage Current	$I_{GSS1}$	$V_{GS}=\pm 20V, V_{DS}=0V$			$\pm 100$	nA
	$I_{GSS2}$	$V_{GS}=\pm 10V, V_{DS}=0V$			$\pm 50$	nA
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS}=V_{GS}, I_D=250\mu A$	0.4		1.5	V
Static Drain-Source On-Resistance	$R_{DS(on)}$	$V_{GS}=10V, I_D=100mA$		1.3	2.5	$\Omega$
		$V_{GS}=4.5V, I_D=50mA$		1.5	3.0	
Diode Forward Voltage	$V_{SD}$	$I_S=100mA, V_{GS}=0V$			1.2	V
Maximum Body-Diode Continuous Current	$I_S$				100	mA
<b>Dynamic Parameters</b>						
Input Capacitance	$C_{iss}$	$V_{DS}=25V, V_{GS}=0V, f=1MHz$		17.5		$\mu F$
Output Capacitance	$C_{oss}$			11.5		
Reverse Transfer Capacitance	$C_{rss}$			6.5		
<b>Switching Parameters</b>						
Total Gate Charge	$Q_g$	$V_{GS}=10V, V_{DS}=25V, I_D=0.3A$		1.7	2.4	nC
Turn-on Delay Time	$t_{D(on)}$	$V_{GS}=10V, V_{DD}=25V, I_D=300mA, R_{GEN}=6\Omega$		5		ns
Turn-off Delay Time	$t_{D(off)}$			17		
Reverse recovery Time	$t_{rr}$	$V_{GS}=0V, I_S=300mA, V_R=25V, di_S/dt=-100A/\mu s$		30		ns

A. Pulse Test: Pulse Width  $\leq 300\mu s$ , Duty cycle  $\leq 2\%$ .

B. Device mounted on FR-4 PCB, 1 inch x 0.85 inch x 0.062 inch.

## ■ Typical Performance Characteristics

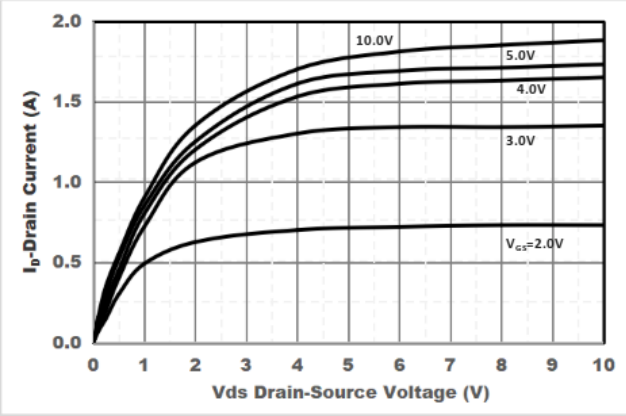


Figure1. Output Characteristics

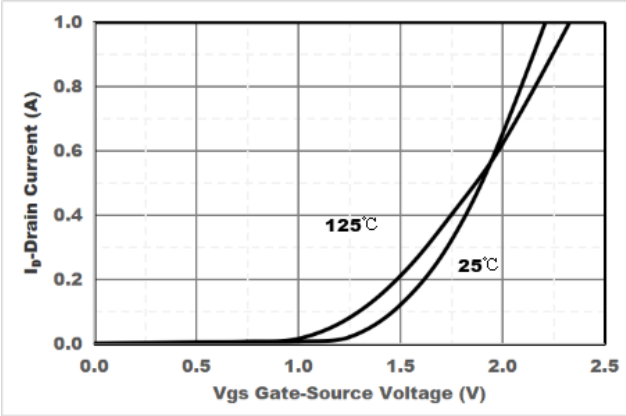


Figure2. Transfer Characteristics

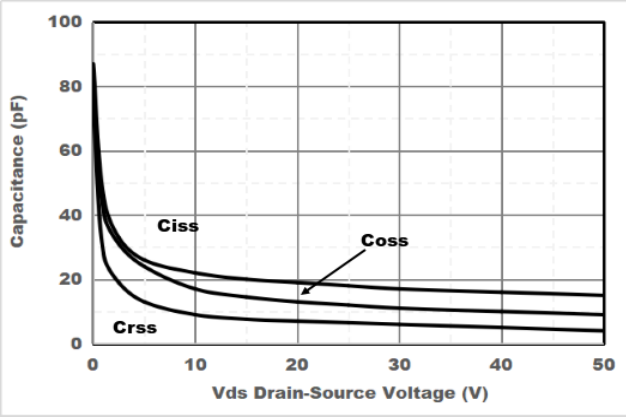


Figure3. Capacitance Characteristics

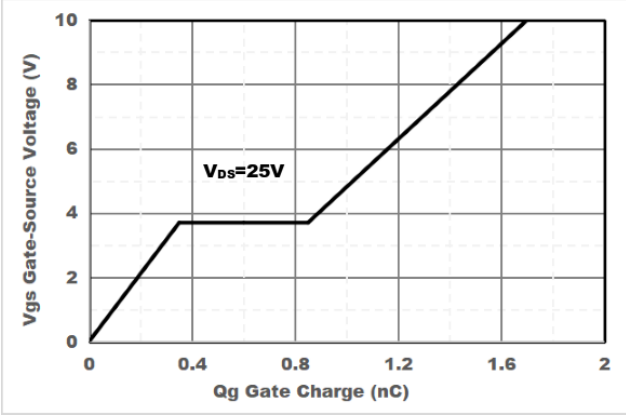


Figure4. Gate Charge

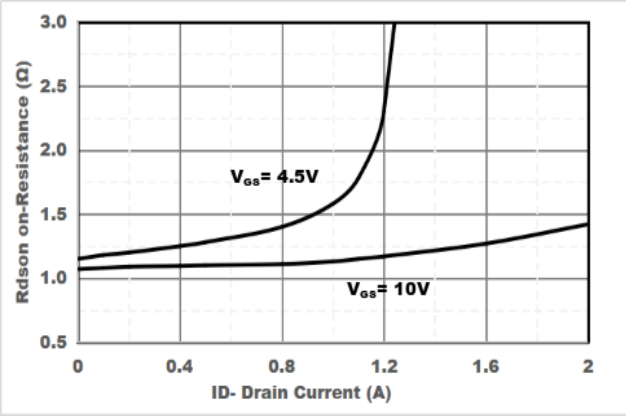


Figure5. Drain-Source on Resistance

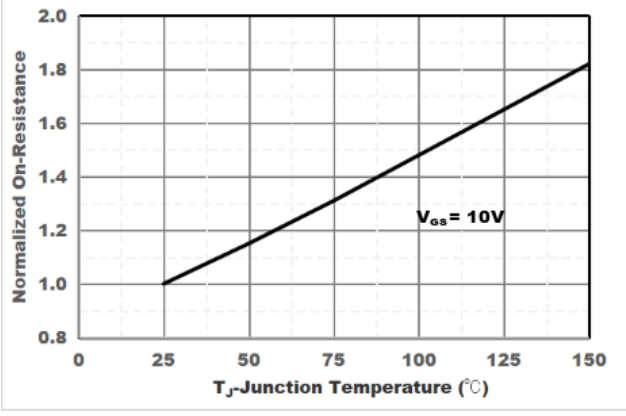


Figure6. Drain-Source on Resistance

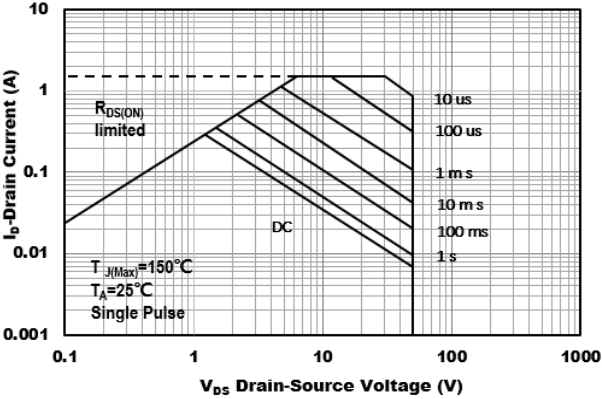


Figure7. Safe Operation Area

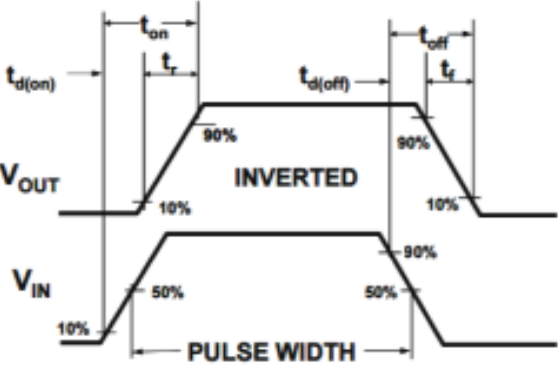
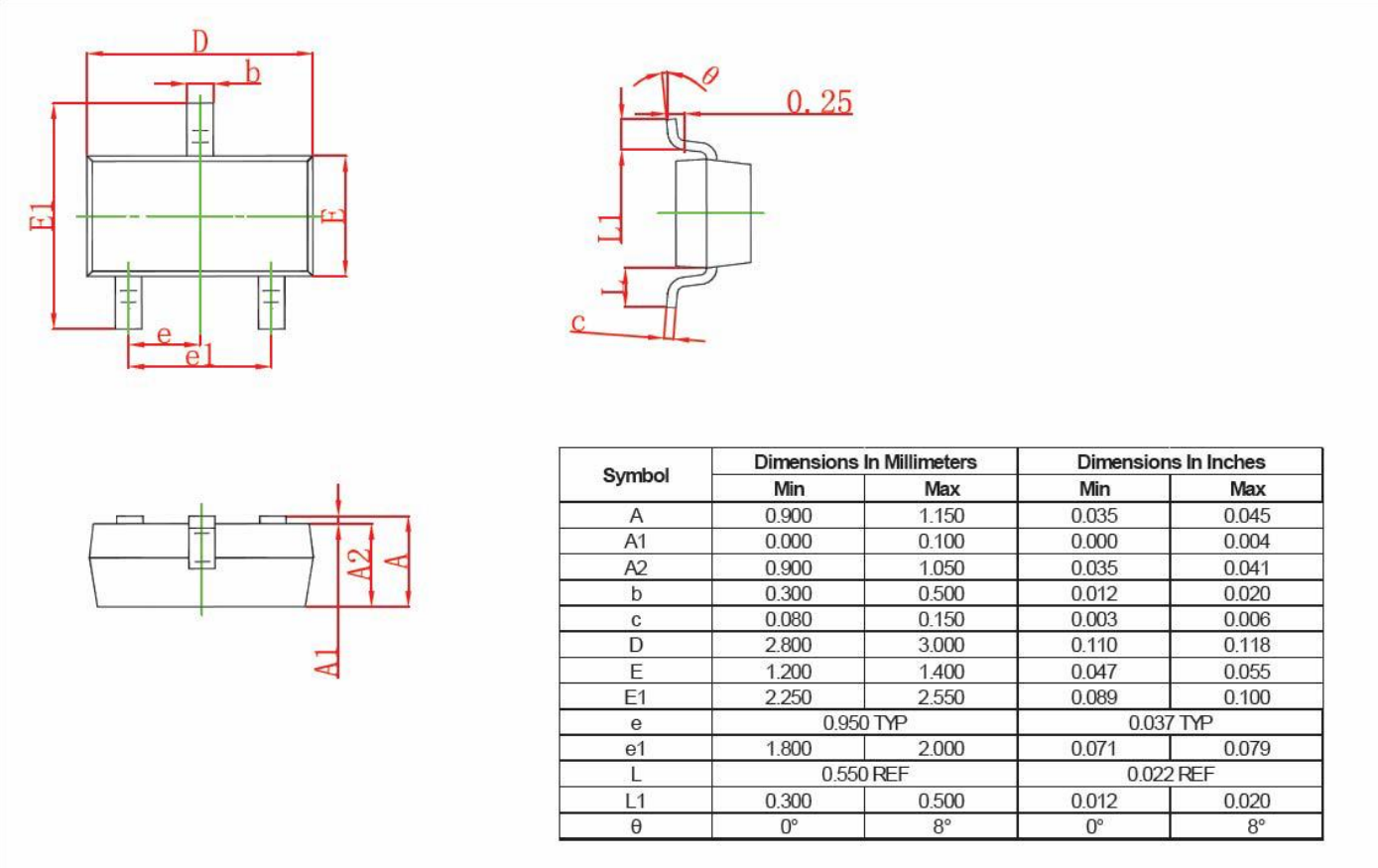


Figure8. Switching wave

■ SOT-23 Package information



■ SOT-23 Suggested Pad Layout

